



# Optocoupler as Optical Isolator for SPI Bus System

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## INTRODUCTION

The serial peripheral interface (SPI) bus as shown in Fig. 1 is a synchronous serial, four-wire, multi-user bus with a clock frequency up to a few MHz. The application areas are inter-chip communication in audio and measurement, LCD displays, SD cards, etc. The SPI bus consists of four lines: a serial clock line (SCLK), master output slave input (MOSI), master input slave output (MISO), and optional slave select (SS).

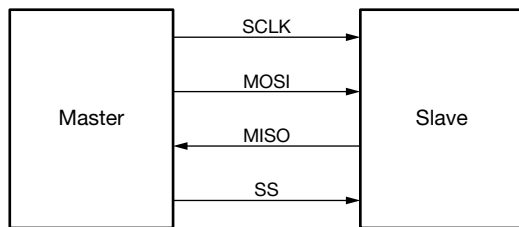


Fig. 1 - 1 Master - 1 Slave SPI Connection

Each line is uni-directional. The master selects a slave by pulling the slave select (SS) line to the logic “L” stage and can communicate with the chosen slave.

In case of more than one slave, each slave needs its own slave select (SS) line.

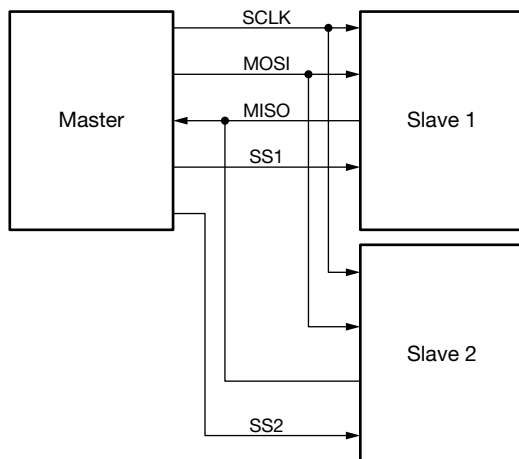


Fig. 2 - 1 Master - 2 Slaves SPI Connection

## OPTICAL ISOLATION

In case of electrical noise, coupling effects, or level shifting requirements, an optocoupler is a perfect solution for isolating a master and slave. Due to galvanic isolation, an optocoupler helps to break up ground loops and reduce the noise due to optical light transmission across an isolation barrier. It can also restore the signal logic level and further be used for signal level transforming between different voltage levels, e.g. from 5 V to 3.3 V.

One channel is required for the serial clock line (SCLK), one for the forward data transmission (MOSI), one for the backward data transmission (MISO), and one channel for the slave select line (SS) as shown in Fig. 1.

## DESIGN CONSIDERATIONS

When the slave select line (SS) is pulled down to the logic “L” stage, a voltage divider is formed by the pull-up resistor ( $R_P$ ) and the internal NMOS drain source junction. The output voltage ( $V_O$ ) is the voltage drop of the open drain output ( $V_{OL}$ ), as shown in Fig. 3.

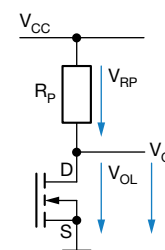


Fig. 3 - Voltage Divider

For the logic “H” stage, pull-up resistors ( $R_P$ , as shown in Fig. 4) are required and can be calculated with Equation 1 below:

$$R_P = \frac{V_{CC} - V_{OL}}{I_{OL}} \quad (1)$$

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## EXAMPLE CIRCUIT

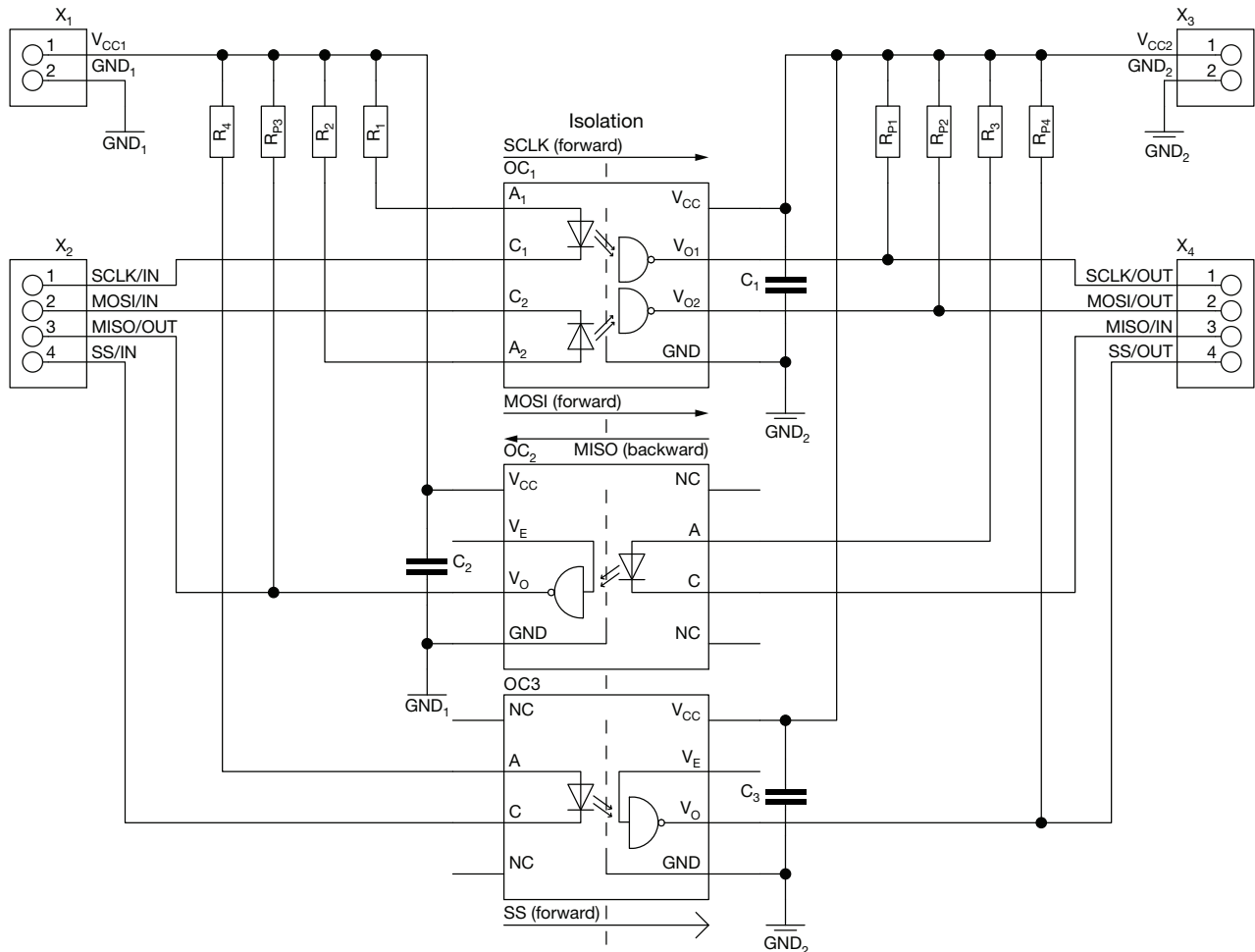


Fig. 4 - Example Schematic for Optical SPI Isolator

Fig. 4 depicts an exemplary optical SPI isolator circuit. Vishay’s 10 MBd high speed optocouplers are used: a single channel VOH260A <sup>(1)</sup> for OC<sub>2</sub> (MISO (forward)) and OC<sub>3</sub> (SS (forward)), and a dual-channel VOH263A <sup>(2)</sup> for OC<sub>1</sub> (SCLK / MOSI (forward)). Both are available in DIP-8 and SOIC-8 packages, named as VOIH060A <sup>(3)</sup> and VOIH063A <sup>(4)</sup>.

By assuming that SCLK/IN (X<sub>2</sub>), MOSI/IN (X<sub>2</sub>), MISO/IN (X<sub>4</sub>), and SS/IN (X<sub>2</sub>) are at the logic “L” stage (saturation voltage drop of connected devices at X<sub>2</sub> and X<sub>4</sub> is neglected), the resistors R<sub>1</sub>, R<sub>2</sub>, R<sub>3</sub>, and R<sub>4</sub> set the forward current (I<sub>F</sub>) through the emitter LEDs of the optocoupler (OC<sub>1</sub>, OC<sub>2</sub>, and OC<sub>3</sub>) inputs and can be calculated with Equations 2 and 3:

$$R_1 = R_2 = R_4 = \frac{V_{CC1} - V_F}{I_F} \quad (2)$$

$$R_3 = \frac{V_{CC2} - V_F}{I_F} \quad (3)$$

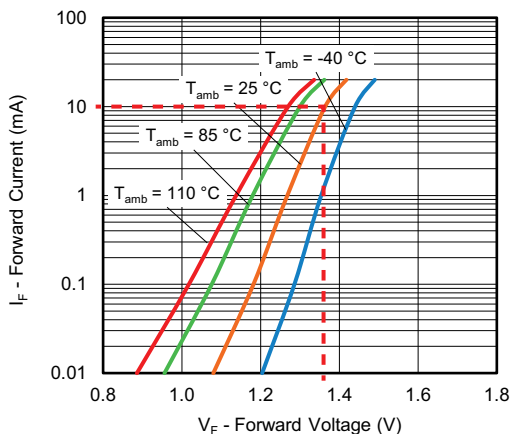
According to the datasheet figure “Voltage vs. Forward Current”, <sup>(1)</sup> a voltage drop (V<sub>F</sub>) of 1.35 V is caused by a forward current (I<sub>F</sub>) of 10 mA through the input LED, as shown in Fig. 5.

### Notes

- (1) [www.vishay.com/ppg?80354](http://www.vishay.com/ppg?80354)
- (2) [www.vishay.com/ppg?80355](http://www.vishay.com/ppg?80355)
- (3) [www.vishay.com/ppg?80356](http://www.vishay.com/ppg?80356)
- (4) [www.vishay.com/ppg?80357](http://www.vishay.com/ppg?80357)

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 Fig. 5 - VOH260A Datasheet –  $V_F$  vs.  $I_F$ 

By using 5 V as the supply voltage ( $V_{CC1}$ ,  $V_{CC2}$ ), values for the resistors  $R_1$ ,  $R_2$ ,  $R_3$ , and  $R_4$  can be calculated using Equations 4 and 5:

$$R_1 = R_2 = R_4 = \frac{5 \text{ V} - 1.35 \text{ V}}{10 \text{ mA}} = 365 \Omega \quad (4)$$

$$R_3 = \frac{5 \text{ V} - 1.35 \text{ V}}{10 \text{ mA}} = 365 \Omega \quad (5)$$

The capacitors  $C_1$ ,  $C_2$ , and  $C_3$  stabilize the power supply and should be placed as close as possible to the optocouplers  $OC_1$ ,  $OC_2$ , and  $OC_3$ .

### Note

(1) The closest value to a resistor E series can be chosen

### TRANSMISSION

When SCLK/IN ( $X_2$ ) is at the logic “H” stage, no forward current ( $I_F$ ) is flowing through the emitter LED ( $A_1 / C_1$ ) and the optocoupler  $OC_1$  output  $V_{O1}$  is also at the logic “H” stage. When SCLK/IN ( $X_2$ ) is at the logic “L” stage, forward current ( $I_F$ ) is flowing through the emitter LED ( $A_1 / C_1$ ) and the optocoupler  $OC_1$  output  $V_{O1}$  is also at the logic “L” stage.

When MOSI/IN ( $X_2$ ) is at the logic “H” stage, no forward current ( $I_F$ ) is flowing through the emitter LED ( $A_2 / C_2$ ) and the optocoupler  $OC_1$  output  $V_{O2}$  is also at the logic “H” stage.

When MOSI/IN ( $X_2$ ) is at the logic “L” stage, forward current ( $I_F$ ) is flowing through the emitter LED ( $A_2 / C_2$ ) and the optocoupler  $OC_1$  output  $V_{O2}$  is also at the logic “L” stage.

When MISO/IN ( $X_4$ ) is at the logic “H” stage, no forward current ( $I_F$ ) is flowing through the emitter LED ( $A / C$ ) and the

optocoupler  $OC_2$  output  $V_O$  is also at the logic “H” stage.

When MISO/IN ( $X_4$ ) is at the logic “L” stage, forward current ( $I_F$ ) is flowing through the emitter LED ( $A / C$ ) and the optocoupler  $OC_2$  output  $V_O$  is also at the logic “L” stage.

When SS/IN ( $X_2$ ) is at the logic “H” stage, no forward current ( $I_F$ ) is flowing through the emitter LED ( $A / C$ ) and the optocoupler  $OC_3$  output  $V_O$  is also at the logic “H” stage.

When SS/IN ( $X_2$ ) is at logic “L” stage, forward current ( $I_F$ ) is flowing through the emitter LED ( $A / C$ ) and the optocoupler  $OC_3$  output  $V_O$  is also at the logic “L” stage.

### RECOMMENDED PARTS

**TABLE 1 - OPTICAL SPI ISOLATOR**

IDENTIFIER	COMMENT
$X_1$	Pin header, 2 circuits
$X_2$	Pin header, 4 circuits
$X_3$	Pin header, 2 circuits
$X_4$	Pin header, 4 circuits
$R_1$	365 $\Omega$ resistance
$R_2$	365 $\Omega$ resistance
$R_3$	365 $\Omega$ resistance
$R_4$	365 $\Omega$ resistance
$R_{P1}$	350 $\Omega$ resistance (1)
$R_{P2}$	350 $\Omega$ resistance (1)
$R_{P3}$	350 $\Omega$ resistance (1)
$R_{P4}$	350 $\Omega$ resistance (1)
$C_1$	100 nF capacitance
$C_2$	100 nF capacitance
$C_3$	100 nF capacitance
$OC_1$	10 MBd (dual) high speed optocoupler VOH263A
$OC_2$	10 MBd (single) high speed optocoupler VOH260A
$OC_3$	10 MBd (single) high speed optocoupler VOH260A

### Note

(1) Recommended load resistance

### CONCLUSION

It can be seen that by using Vishay’s 10 MBd high speed optocoupler series, it is easily possible to galvanically isolate SPI bus systems. Ground loops and electrical noise can be eliminated due to long term proven and robust optical isolation technology.

Choosing Vishay’s small and compact SOIC-8 package saves board space. The availability of dual-channel, high speed optocouplers in one package provides additional board space savings.